

N-Channel Reduced Q_g , Fast Switching MOSFET

PRODUCT SUMMARY						
V _{DS} (V)	$R_{DS(on)}$ (Ω)	I _D (A)	Q _g (Typ.)			
30	0.007 at V _{GS} = 10 V	16	11			
	0.0095 at V _{GS} = 4.5 V	13.5				

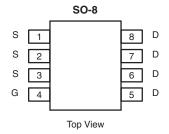
FEATURES

- Halogen-free According to IEC 61249-2-21 Available
- TrenchFET[®] Gen II Power MOSFETs
- PWM Optimized
- 100 % R_g Tested

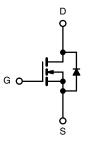
ROHS COMPLIANT HALOGEN FREE Available

APPLICATIONS

• DC/DC Conversion for PC



Ordering Information: Si4386DY-T1-E3 (Lead (Pb)-free) Si4386DY-T1-GE3 (Lead (Pb)-free and Halogen-free)



N-Channel MOSFET

Parameter		Symbol	10 s	Steady State	Unit
Drain-Source Voltage		V_{DS}	30		V
Gate-Source Voltage		V_{GS}	± 20		v
Continuous Drain Current (T _{.I} = 150 °C) ^a	T _A = 25 °C	I _D	16	11	
Continuous Diain Current (1 _J = 150 °C)	T _A = 70 °C		13	9	
Pulsed Drain Current		I _{DM}	± 50		Α
Continuous Source Current (Diode Conduction) ^a		I _S	2.8	1.3	
Single Pulse Avalanche Current	L = 0.1 mH	I _{AS}	20 20		
Avalanche Energy	L = 0.111111	E _{AS}			mJ
Maniana Barray Disairakian d	T _A = 25 °C	P _D	3.1	1.47	W
Maximum Power Dissipation ^a	T _A = 70 °C	' D	2	0.95	VV
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55	5 to 150	°C

THERMAL RESISTANCE RATINGS						
Parameter		Symbol	Typical	Maximum	Unit	
Maximum landing to Audient (MOOFET)	t ≤ 10 s	R _{thJA}	34	40		
Maximum Junction-to-Ambient (MOSFET) ^a	Steady State	' 'thJA	71	85	°C/W	
Maximum Junction-to-Foot (Drain)	Steady State	R_{thJF}	18	22		

Notes

a. Surface Mounted on 1" x 1" FR4 board.

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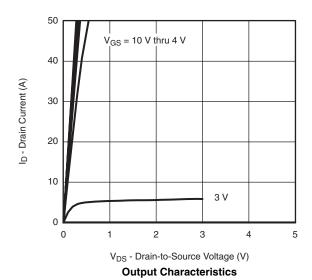
Devementer	$T_J = 25$ °C, unless otherwise noted Symbol Test Conditions Min			Tirm	Max	I I m la	
Parameter	Symbol	lest Conditions	Min.	Тур.	Max.	Unit	
Static							
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	1.5	2.0	2.5	V	
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			± 100	nA	
Zara Cata Valtaga Drain Current	I _{DSS}	V _{DS} = 30 V, V _{GS} = 0 V			1		
Zero Gate Voltage Drain Current		V _{DS} = 30 V, V _{GS} = 0 V, T _J = 70 °C			10	μΑ	
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge 5 \text{ V}, V_{GS} = 10 \text{ V}$	40			Α	
D : 0	D	V _{GS} = 10 V, I _D = 16 A	0.0058		0.007	0	
Drain-Source On-State Resistance ^a	R _{DS(on)}	$V_{GS} = 4.5 \text{ V}, I_D = 13.5 \text{ A}$		0.0078	0.0095	Ω	
Forward Transconductance ^a	9 _{fs}	V _{DS} = 15 V, I _D = 16 A		51		S	
Diode Forward Voltage ^a	V_{SD}	I _S = 2.8 A, V _{GS} = 0 V		0.75	1.1	V	
Dynamic ^b			•	•			
Total Gate Charge	Qg			11	18		
Gate-Source Charge	Q_{gs} V_{DS}	$V_{DS} = 15 \text{ V}, V_{GS} = 4.5 \text{ V}, I_{D} = 16 \text{ A}$		5.8		nC	
Gate-Drain Charge	Q_{gd}			3.0			
Gate Resistance	R_{g}		0.8	1.7	2.5	Ω	
Turn-On Delay Time	t _{d(on)}			12	18		
Rise Time	t _r	V_{DD} = 15 V, R_L = 15 Ω		9	14		
Turn-Off Delay Time	$t_{d(off)}$ $I_D \cong 1 \text{ A, } V_{GEN} = 10 \text{ V, } R_g = 6 \Omega$			35	53	ns	
Fall Time	t _f			10	15		
Source-Drain Reverse Recovery Time	t _{rr}	$I_{\rm F} = 2.8 \text{ A}, dI/dt = 100 A/\mu s$		25	50		

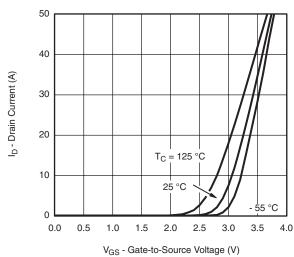
Notes:

- a. Pulse test; pulse width $\leq 300~\mu s,$ duty cycle $\leq 2~\%.$
- b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted





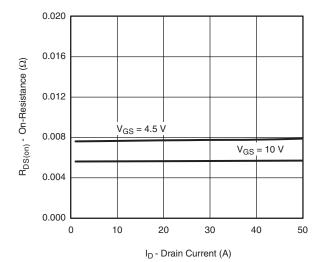
Transfer Characteristics



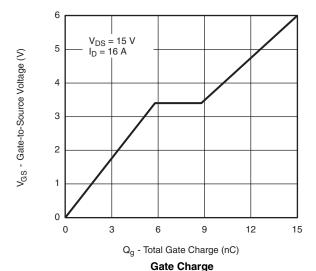




TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



On-Resistance vs. Drain Current

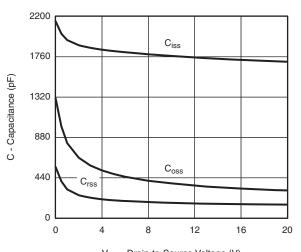


T_J = 150 °C

T_J = 150 °C

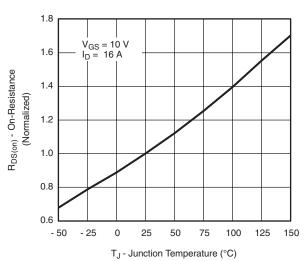
T_J = 25 °C

 V_{SD} - Source-to-Drain Voltage (V) **Source-Drain Diode Forward Voltage**

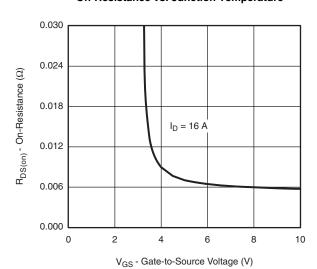


V_{DS} - Drain-to-Source Voltage (V)





On-Resistance vs. Junction Temperature



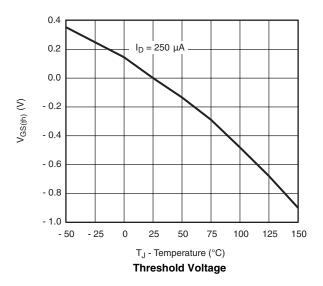
On-Resistance vs. Gate-to-Source Voltage

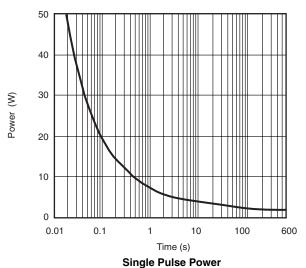
I_S - Source Current (A)

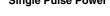
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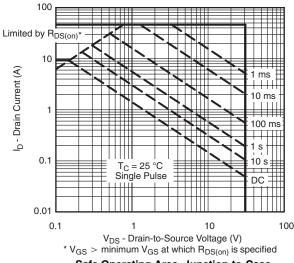
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TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

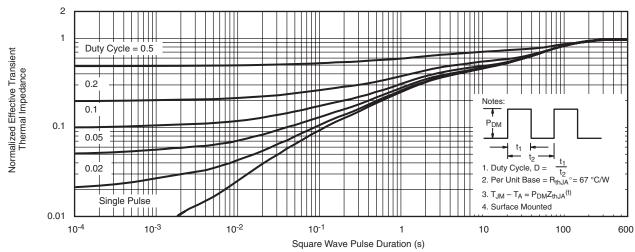








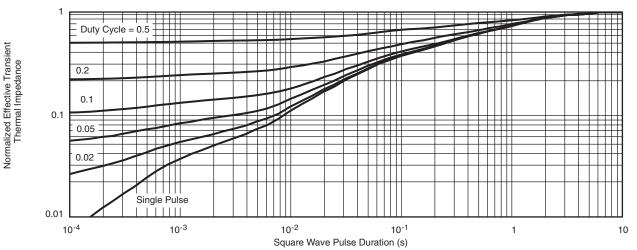




Normalized Thermal Transient Impedance, Junction-to-Ambient

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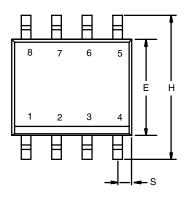


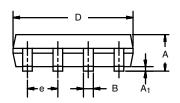
Normalized Thermal Transient Impedance, Junction-to-Foot

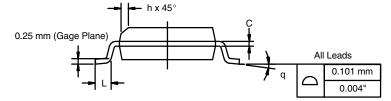
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SOIC (NARROW): 8-LEAD JEDEC Part Number: MS-012







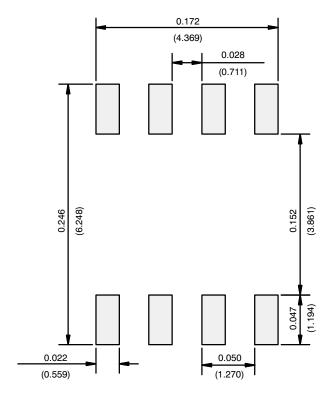
	MILLIM	IETERS	INCHES			
DIM	Min	Max	Min	Max		
Α	1.35	1.75	0.053	0.069		
A ₁	0.10	0.20	0.004	0.008		
В	0.35	0.51	0.014	0.020		
С	0.19	0.25	0.0075	0.010		
D	4.80	5.00	0.189	0.196		
Е	3.80	4.00	0.150	0.157		
е	1.27 BSC		0.050	50 BSC		
Н	5.80	6.20	0.228	0.244		
h	0.25	0.50	0.010	0.020		
L	0.50	0.93	0.020	0.037		
q	0°	8°	0°	8°		
S	0.44	0.64	0.018	0.026		
ECN: C-06527-Rev. I. 11-Sep-06						

DWG: 5498

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RECOMMENDED MINIMUM PADS FOR SO-8



Recommended Minimum Pads Dimensions in Inches/(mm)

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